

Semiconductor Prototyping Program: Business Case Template

[Place Company Logo
Here]

1. COMPANY INFORMATION

Company Name:

Date of Submission (DD/MM/YYYY):

Headquarters Address:

Establishment Date (DD/MM/YY):

Line of Business:

☒ Semiconductors

Current Full-Time R&D Employees:

Annual Revenue (EGP):

Annual Exports (EGP):

2. FINANCIAL & TAPE-OUT PROPOSAL

Chip / Project Name	Manufacturer / Foundry	Target Tape-Out Date	Prototyping Cost (EGP)
Total Prototyping Budget			EGP _____

3. REQUIRED DOCUMENTS CHECKLIST

- ☐ Commercial Registration Certificate
- ☐ Valid Tax Card
- ☐ IT Services License issued by ITIDA

- ☐ Official Social Insurance Printout for full-time R&D staff (or an Employment Certificate signed by an external auditor)
- ☐ Signed Agreement, Foundry Contract, or Official Price Quote for the chip fabrication/tape-out